PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3005140

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIDEKI ITO	07/28/2014
KUNIHIKO SUZUKI	07/28/2014
HIDEKAZU TSUCHIDA	07/09/2014
ISAHO KAMATA	07/09/2014
MASAHIKO ITO	07/09/2014
HIROAKI FUJIBAYASHI	07/08/2014
MASAMI NAITO	07/08/2014
AYUMU ADACHI	07/09/2014
KOICHI NISHIKAWA	07/04/2014

RECEIVING PARTY DATA

Name:	NUFLARE TECHNOLOGY INC.	
Street Address:	8-1 SHIN SUGITA-CHO, ISOGO-KU	
City:	YOKOHAMA-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14473157	

CORRESPONDENCE DATA

Fax Number: (202)408-4400

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2024084000

Email: bernie.carson@finnegan.com

Correspondent Name: FINNEGAN

Address Line 1: 901 NEW YORK AVENUE, NW Address Line 4: WASHINGTON, DC, D.C. 20001

ATTORNEY DOCKET NUMBER:	12390.0009
NAME OF SUBMITTER:	B.CARSON
SIGNATURE:	/B.CARSON/
DATE SIGNED:	09/02/2014
	PATENT

502958542 REEL: 033650 FRAME: 0374

	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 15	
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PATENT REEL: 033650 FRAME: 0375

ASSIGNMENT AND DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS I/We, the below named inventor(s), (hereinafter referred to as Assignor(s)), of a claimed invention in an application for United States Letters Patent entitled:

FILI	M FORMATION APPARATUS AND FILM FO	RMATION WETHOD	
filed herewith or on hereto and/or PCT Internation	as United States Application No.	(Confirmation No.) attached
WHEREAS, NuFlare Techra corporation of Japan	nology inc.		
	8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama		
(hereinafter referred to as Ass application for United States L	Ignee), is desirous of securing the entire righ etters Patent on this invention and the Letter	t, title, and interest in and to s Patent to be issued upon t	this invention, the his application;
acknowledged, I/WE, as Assig and set over unto the Assigne invention and this application, which may be granted thereor	wn that, for good and valuable consideration inor(s), have sold, assigned, transferred, and e, its lawful successors and assigns, my/our and all divisions, and continuations thereof, a n, and all relesues thereof; and IAVE hereby a Office to issue all Letters Patent for this inver of this Assignment;	I set over, and do hereby sel entire right, title, and interest and all Letters Patent of the authorize and request the Oli	I, essign, transfer, t in and to this United States rector of the United
its successors and assigns, and lawful papers when called upo- title to this invention in said As- applications, make all rightful obtain and enforce proper pat	ovenant and agree that I/We will, without furting facts known to me/us respecting this invention to do so, execute and deliver all papers the signee, its successors and assigns, execute caths and generally do everything possible to ent protection for this invention in the United to papers shall be borne by the Assignee, its	ntion and testify in any legal p at may be necessary or desingled all divisional, continuation, a paid Assignee, its successor States, it being understood t	oroceeding, sign all rable to perfect the and releaue rs and assigns, to
AND, IWE HEREBY authorized parentheses (Application No. application when known.	e and request that the attorneys having Powe	er of Attorney in this application the filing date and application	on, insert here in n number of said
(2) the above-identified applic as stated below next to my na invention in the application. I	hereby declare that: (1) This declaration is d ation was made or authorized to be made by me; and (4) I believe I am an original invento hereby acknowledge that any willful false stat ment of not more than five (5) years, or both,	me; (3) my residence and m r or an original joint inventor tements made in this declars	ailing address are of a claimed . ation are
	have reviewed and understand the contents to the USPTO all information known to me to		
14/473,157 filed Augu	st 29, 2014		*
			*

Page 1 of 3

PATENT REEL: 033650 FRAME: 0376

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above identified patent application is filed to have access to the above identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filling the Authorization to Permit Access to Application by Participating Offices.

1. FULL NAME OF SOLE OR FIRST ASSIGNOR Hideki ITO	ASSIGNOR'S SIGNATURE Hideki Ito	DATE July 28, 2014
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kanawaga-Ken, Japan		RESIDENCE Yokohama-Shi Kanagawa-Ken, Japan
2. FULL NAME OF SECOND ASSIGNOR, IF ANY Kunihiko SUZUKI	ASSIGNOR'S SIGNATURE Kunihiko Suzuki	DATE July 28, 2014
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kani		RESIDENCE Suntou-Gun Shizuoka-Ken, Japan
3. FULL NAME OF THIRD ASSIGNOR, IF ANY Hidekazu TSUCHIDA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Central Research Institute of Electric Power Industry 2-6-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Japan		RESIDENCE Yokosuka-Shi Kanagawa-Ken, Japan
4. FULL NAME OF FOURTH ASSIGNOR, IF ANY ISAHO KAMATA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-6-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja		RESIDENCE Tokyo, Japan
5. FULL NAME OF SOLE OR FIRST ASSIGNOR Masahiko ITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-8-1, Nagasaka, Yokosuke-Shi, Kanagawa-Ken, Ja		RESIDENCE Yokosuka-Shi Kanagawa-Ken, Japan

	\$	
6. FULL NAME OF SECOND ASSIGNOR, IF ANY Hiroaki FUJIBAYASHI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Denso Corporation 1-1, Showa-Cho, Karlye-Shi, Alchi-Ken, Japan	d	RESIDENCE Zushi-Shi Kanagawa-Ken, Japan
7. FULL NAME OF THIRD ASSIGNOR, IF ANY Masami NAITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Denso Corporation 1-1, Showa-Cho, Kariya-Shi, Alchi-Ken, Japan	,	RESIDENCE Inazawa-Shi Alchi-Ken, Japan
8. FULL NAME OF FOURTH ASSIGNOR, IF ANY Ayumu ADACHI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Toyota Jidosha Kabushiki Kelsha 1, Toyota-Cho, Toyota-Shi, Alchi-Ken, Japan		RESIDENCE Toyota-Shi Alchi-Ken, Japan
9. FULL NAME OF FOURTH ASSIGNOR, IF ANY Kolchi NISHIKAWA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Kabushiki Kaisha Toyota Chuo Kenkyusho 41-1, Yokomichi, Nagakute-Shi, Aichi-Ken, Japan	1	RESIDENCE Nagoya-Shi Alchi-Ken, Japan

ASSIGNMENT AND DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION

FILM FORMATION APPARATUS AND FILM FO	ORMATION METHOD	
filed herewith or on as United States Application No. hereto and/or PCT International Application No.	(Confirmation No.) attached
WHEREAS, Nisflace Technology Inc. a corporation of Japan	<u> </u>	
whose post office address is 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama		
(hereinafter referred to as Assignee), is desirous of securing the entire righ application for United States Letters Patent on this invention and the Letter		
NOW THEREFORE, be it known that, for good and valuable consideration acknowledged, I/WE, as Assignor(s), have sold, assigned, transferred, and and set over unto the Assignee, its lawful successors and assigns, my/our invention and this application, and all divisions, and continuations thereof, which may be grented thereon, and all reissues thereof; and I/WE hereby a States Patent and Trademark Office to issue all Letters Patent for this invent accordance with the terms of this Assignment;	is et over, and do hereby sell, entire right, title, and interest li and all Letters Patent of the Ui authorize and request the Dire	assign, transfer, n and to this nited States ctor of the United
AND, I/WE HEREBY further covenant and agree that I/We will, without furt its successors and assigns, any facts known to me/us respecting this invertantly papers when called upon to do so, execute and deliver all papers the citle to this invention in said Assignee, its successors and assigns, execute applications, make all rightful oaths and generally do everything possible to obtain and enforce proper patent protection for this invention in the United notdent to the execution of such papers shall be borne by the Assignee, its	ntion and testify in any legal pro at may be necessary or desiral all divisional, continuation, and all divisional, the successors States, it being understood the	oceeding, sign all ble to perfect the d reissue and assigns, to
AND, I/WE HEREBY authorize and request that the attorneys having Power parentheses (Application No, filed) application when known.	er of Attorney in this application the filing date and application	n, insert here in number of said
As a named inventor below, I hereby declare that: (1) This declaration is d (2) the above-identified application was made or authorized to be made by as stated below next to my name; and (4) I believe I am an original invento nvention in the application. I hereby acknowledge that any willful false stabunishable by fine or imprisonment of not more than five (5) years, or both, States Code.	me; (3) my residence and mai or or an original joint inventor of tements made in this declarati	ling address are f a claimed on are
As a below named inventor, I have reviewed and understand the contents aware of the duty to disclose to the USPTO all information known to me to 37C.F.R. § 1.56.	of the application, including the be material to patentability as	e claims, and am defined in

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean intellectual Property Office (KIPO), the World intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-identified patent application is filed to have access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above identified patent application.

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In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

FULL NAME OF SOLE OR FIRST ASSIGNOR Hideki ITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohame-Shi, Kan	awaga-Ken, Japan	RESIDENCE Yokohama-Shi Kanagawa-Ken, Japan
2. FULL NAME OF SECOND ASSIGNOR, IF ANY Kunihiko SUZUKI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kan	awaga-Ken, Japan	RESIDENCE Suntou-Gun Shizuoka-Ken, Japan
3. FULL NAME OF THIRD ASSIGNOR, IF ANY Hidekazu TSUCHIDA	ASSIGNOR'S SIGNATURE Utitakar Truchido	DATE July 9, 2014
MAILING ADDRESS c/c Central Research Institute of Electric Power Indu 2-6-1, Nagasaka, Yokosuka-Shl, Kanagawa-Ken, Ja		RESIDENCE Yokosuka-Shi Kanagawa-Ken, Japan
4. FULL NAME OF FOURTH ASSIGNOR, IF ANY Isaho KAMATA	ASSIGNOR'S SIGNATURE ISaho Kamata	DATE July 9. 2014
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-6-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja		REŜIDENCE Tokyo, Japan
5. FULL NAME OF SOLE OR FIRST ASSIGNOR Masahiko ITO	assignor's signature Masahàk Ito	DATE July, 9, 2014
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-5-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja	stry	RESIDENCE Yokosuka-Shi Kanagawa-Ken, Japan

6. FULL NAME OF SECOND ASSIGNOR, IF ANY Hiroaki FUJIBAYASHI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Denso Corporation 1-1, Showa-Cho, Kariya-Shi, Alchi-Ken, Japan		RESIDENCE Zushl-Shl Kanagawa-Ken, Japan
7. FULL NAME OF THIRD ASSIGNOR, IF ANY Masami NAITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Denso Corporation 1-1, Showa-Cho, Kariya-Shi, Aichi-Ken, Japan		RESIDENCE Inazawa-Shi Alchi-Ken, Japan
8. FULL NAME OF FOURTH ASSIGNOR, IF ANY Ayumu ADACHI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Toyota Jidosha Kabushiki Kaisha 1, Toyota-Cho, Toyota-Shi, Alchi-Ken, Japan		RESIDENCE Toyota-Shi Alchi-Ken, Japan
9. FULL NAME OF FOURTH ASSIGNOR, IF ANY Kolchi NISHIKAWA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Kabushiki Kalsha Toyota Chuo Kenkyusho 41-1, Yokomichi, Nagakuta-Shi, Alchi-Ken, Japan	J	RESIDENCE Nagbya-Shi Alchi-Ken, Japan

ASSIGNMENT AND DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION

ANDROGRAPHS (Sec. 11)	FILI	A FORMATION A	APPARATUS ANI	OFILM FORMA	COHTEM MOIT	
filed herewith or o hereto and/or PC	าก	as United S	tales Application		(Confirmation No.) attached
WHEREAS, No a corporation of	uFlare Techn Japan		× ×			*
a sorboration of	aspan	**********	************************			
whose post office	address is	8-1 Shin Sugita	-Cho, Isogo-Ku, `	∕okohama-Shi,	Kanagawa-Ken, Jap	oan
	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~		*****************			
(hereinafter referr application for Un	ed to as Ass ited States L	gnee), is destrou etters Patent on i	s of securing the this invention and	entire right, title the Letters Pal	e, and Interest in and tent to be issued upo	to this invention, the n this application;
acknowledged, I/I and set over unto invention and this which may be gra	NE, as Assig the Assigner application, nted thereon I Trademark	nor(s), have sold o, its lawful succe and all divisions, , and all reissues Office to issue all	l, assigned, transf assors and assign and continuation thereof; and I/Wi Letters Patent fo	erred, and set on the set of the	oright, title, and inter the letters Patent of the rize and request the	sell, assign, transfer, rest in and to this
Its successors an lawful papers who title to this inventi applications, mak obtain and enforc	d assigns, an an called upo on in sald As a all rightful d a proper pats	y facts known to n to do so, execu signee, its succe raths and genera ant protection for	me/us respecting te and deliver all sepre and assigns lly do everything (this invention in the	this invention a papers that ma a, execute all di accepte to aid a accepted State	and testify in any lea	sors and assigns, to d that any expense
AND, I/WE HERE parentheses (App application when	BY authorize lication No known.	and request tha	t the attomeys ha , filed	ving Power of /) the fi	Attomey in this applicating date and applica	cation, insert here in ation number of said
(2) the above-ide as stated below n invention in the a	rlified applica ext io my nar oplication. + I	ition was made o ne; and (4) I beli ereby acknowled	r suthorized to be ave I am an origin age that any willfu	r mada by me; (at inventor or a I false stateme:	ed to the above-ident (3) my residence and n original joint invent nts made in this deci er section 1001 of Tit	I maliing address are tor of a claimed aration are
As a below name aware of the duty 37C,F,R, § 1.56.	d inventor, I f to disclose to	ave reviewed an the USPTO all i	d understand the nformation knowr	contents of the to me to be m	application, includin aterial to patentabilit	g the claims, and am y as defined in

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above identified patent application is filed to have access to the above identified patent application.

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1. FULL NAME OF SOLE OR FIRST ASSIGNOR Hideki ITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kan	awaga-Ken, Japan	REGIDENCE Yokohama-Shi Kanagawa-Ken, Japan
2. FULL NAME OF SECOND ASSIGNOR, IF ANY Kunihiko SUZUKI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kan	awaga-Ken, Japan	RESIDENCE Suntou-Gun Shizuoka-Ken, Japan
3. FULL NAME OF THIRD ASSIGNOR, IF ANY Hidekezu TSUCHIDA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS ofe Central Research Institute of Electric Power Indu 2-6-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja		RESIDENCE Yokosuka-Shi Kenagawa-Ken, Japan
4. FULL NAME OF FOURTH ASSIGNOR, IF ANY Isaho KAMATA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-8-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja		RESIDENCE Tokyo, Japan
5. FULL NAME OF SOLE OR FIRST ASSIGNOR Masahiko ITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-8-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja		RESIDENCE Yokosuka-Shi Kanagawa-Kan, Japan

B. FULL NAME OF SECOND ASSIGNOR, IF ANY Hiroaki FWIBAYASHI	ASSIGNOR'S SIGNATURE Horoaki Huilbonashi	DATE July, 8,20/4
MAILING ADDRESS c/o Denso Corporation 1-1, Showa-Cho, Kariya-Shi, Alchi-Ken, Japan	i stoodan pagaaan	RESIDENCE Zushi-Shi Kanagawa-Ken, Japan
7. FULL NAME OF THIRD ASSIGNOR, IF ANY Masami NAITO	ASSIGNOR'S SIGNATURE MASAMI NOITO	DATE July 8 2014
MAILING ADDRESS c/o Denso Corporation 1-1, Showa-Cho, Kariya-Shi, Alchi-Ken, Japan		RESIDENCE Inazawa-Shi Alchi-Ken, Japan
8. FULL NAME OF FOURTH ASSIGNOR, IF ANY Ayumu ADACHI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Toyota Jidosha Kabushiki Kaisha 1, Toyota-Cho, Toyota-Shi, Aichi-Ken, Japan	``	RESIDENCE Toyota-Shi Alchi-Ken, Japan
9. FULL NAME OF FOURTH ASSIGNOR, IF ANY Koloh i NISHIKAWA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS o/o Kabushiki Kalsha Toyota Chuo Kenkyusho 41-1, Yokomichi, Nagakute-Shi, Alchi-Ken, Japan	. 3	RESIDENCE Nagoya-Shi Alchi-Ken, Japan

ASSIGNMENT AND DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION

FILM FORMATION APPARATUS AND FILM FORMATION METHOD				
filed herewith or on as United States Application No. (Confirm hereto and/or PCT International Application No.	ation No.) sitsched			
WHEREAS, NuFlare Technology Inc. a corporation of Japan				
whose post office address is 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kanagay	va-Ken, Japan			
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest application for United States Letters Patent on this invention and the Letters Patent to be	erest in and to this invention, the issued upon this application;			
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of acknowledged, I/WE, as Assignor(s), have sold, assigned, transferred, and set over, and and set over unto the Assignee, its lawful successors and assigns, my/our entire right, titl invention and this application, and all divisions, and continuations thereof, and all Letters which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and it States Patent and Trademark Office to issue all Letters Patent for this invention to Assign in accordance with the terms of this Assignment;	do hereby sell, assign, transfer, le, and interest in and to this Patent of the United States request the Director of the United			
AND, I/WE HEREBY further covenant and agree that I/We will, without further considerated its successors and assigns, any facts known to me/us respecting this invention and testify lawful papers when called upon to do so, execute and deliver all papers that may be necestitle to this invention in said Assignee, its successors and assigns, execute all divisional, applications, make all rightful oaths and generally do everything possible to aid Assignee obtain and enforce proper patent protection for this invention in the United States, it being incident to the execution of such papers shall be borne by the Assignee, its successors as	y in any legal proceeding, sign all essary or desirable to perfect the continuation, and relssue , its successors and assigns, to a understood that any expense			
AND, I/WE HEREBY authorize and request that the attorneys having Power of Attorney is parentheses (Application No, filed) the filing date application when known.	n this application, insert here in and application number of said			
As a named inventor below, I hereby declare that: (1) This declaration is directed to the a (2) the above-identified application was made or authorized to be made by me; (3) my rea as stated below next to my name; and (4) I believe I am an original inventor or an original invention in the application. I hereby acknowledge that any willful false statements made punishable by fine or imprisonment of not more than five (5) years, or both, under section States Code.	sidence and mailing address are joint inventor of a claimed in this declaration are			
As a below named inventor, I have reviewed and understand the contents of the applicati aware of the duty to disclose to the USPTO all information known to me to be material to 37C.F.R. § 1.56.	on, including the claims, and am patentability as defined in			

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-'KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above identified patent application.

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1. FULL NAME OF SOLE OR FIRST ASSIGNOR Hideki ITO	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kan	RESIDENCE Yokohama-Shi Kanagawa-Ken, Japan	
2. FULL NAME OF SECOND ASSIGNOR, IF ANY Kunihiko SUZUKI	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o NuFlare Technology, Inc. 8-1 Shin Sugita-Cho, Isogo-Ku, Yokohama-Shi, Kan	awaga-Ken, Japan	RESIDENCE Suntou-Gun Shizucka-Ken, Japan
3. FULL NAME OF THIRD ASSIGNOR, IF ANY Hidekazu TSUCHIDA	ASSIGNOR'S SIGNATURE	DATE
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4. FULL NAME OF FOURTH ASSIGNOR, IF ANY Isaho KAMATA	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS c/o Central Research Institute of Electric Power Indu 2-6-1, Nagasaka, Yokosuka-Shi, Kanagawa-Ken, Ja	stry pan	RESIDENCE Tokyo, Japan
5. FULL NAME OF SOLE OR FIRST ASSIGNOR Masahiko ITO	ASSIGNOR'S SIGNATURE	DATE
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ASSIGNMENT AND DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION

FILM	FORMATION APPARATUS AND FILM F	ORMATION METHOD	
filed herewith or on hereto and/or PCT International	as United States Application No.	(Confirmation No.) attached
WHEREAS, NuFlare Technola corporation of Japan	ogy Inc.		
,	8-1 Shin Sugita-Cho, Isogo-Ku, Yokoham	a-Shi, Kanagawa-Ken, Japan	
(hereinafter referred to as Assig application for United States Let	nee), is desirous of securing the entire rigiters Patent on this invention and the Lette	ht, title, and interest in and to the rs Patent to be issued upon thi	ils invention, the s application;
acknowledged, I/WE, as Assigned, and set over unto the Assignee, invention and this application, as which may be granted thereon, a	i that, for good and valuable consideration or (s), have sold, assigned, transferred, and its lawful successors and assigns, my/our its lawful successors and assigns, my/our did all dvisions, and continuations thereof, and all reissues thereof; and I/WE hereby fice to issue all Letters Patent for this investible Assignment;	d set over, and do hereby sell, entire right, title, and interest in and all Letters Patent of the Ur authorize and request the Dire	assign, transfer, n and to this nited States of the United
its successors and assigns, any lawful papers when called upon title to this invention in said Assign applications, make all rightful or obtain and enforce proper paten	enant and agree that I/We will, without fur facts known to me/us respecting this inver- to do so, execute and deliver all papers th gnee, its successors and assigns, execute the and generally do everything possible to protection for this invention in the United papers shall be borne by the Assignee, it	ntion and tealify in any legal pro at may be necessary or desiral all divisional, continuation, and o ald Assignee, its successors i States, it being understood tha	oceeding, sign all ole to perfect the direissue and assigns, to
AND, I/WE HEREBY authorize a parentheses (Application No application when known.	nd request that the attorneys having Pow	er of Attorney in this application the filing date and application i	, insert here in number of said
(2) the above-identified application as stated below next to my name invention in the application. I he	reby declare that: (1) This declaration is on was made or authorized to be made by and (4) I believe I am an original inventoreby acknowledge that any willful false staint of not more than five (5) years, or both	me; (3) my residence and mali r or an original joint inventor of tements made in this declaration	ling address are a claimed
As a below named inventor, I has aware of the duty to disclose to t 37C.F.R. § 1.56.	ve reviewed and understand the contents ne USPTO all information known to me to	of the application, including the be material to patentability as o	claims, and am defined in

If checked, the undersigned hereby grants the USPTO, authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other Intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-'KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

in accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

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